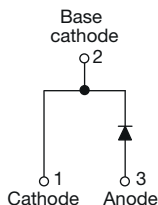


## Fast Soft Recovery Rectifier Diode, 10 A



2L TO-220AC



### FEATURES

- Glass passivated pellet chip junction
- Meets JESD 201 class 1A whisker test
- Flexible solution for reliable AC power rectification
- High surge, low  $V_F$  rugged blocking diode for DC charging stations
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

### APPLICATIONS

- On-board and off-board EV/HEV battery chargers
- Input rectification

### DESCRIPTION

The VS-10ETF12THM3 fast soft recovery rectifier series has been optimized for combined short reverse recovery time and low forward voltage drop.

The glass passivation ensures stable reliable operation in the most severe temperature and power cycling conditions.

### PRIMARY CHARACTERISTICS

$I_{F(AV)}$	10 A
$V_R$	1200 V
$V_F$ at $I_F$	1.33 V
$I_{FSM}$	140 A
$t_{rr}$	80 ns
$T_J$ max.	150 °C
Snap factor	0.6
Package	2L TO-220AC
Circuit configuration	Single

### MAJOR RATINGS AND CHARACTERISTICS

SYMBOL	CHARACTERISTICS	VALUES	UNITS
$V_{RRM}$		1200	V
$I_{F(AV)}$	Sinusoidal waveform	10	A
$I_{FSM}$		140	
$t_{rr}$	1 A, 100 A/μs	80	ns
$V_F$	10 A, $T_J = 25$ °C	1.33	V
$T_J$		-40 to +150	°C

### VOLTAGE RATINGS

PART NUMBER	$V_{RRM}$ , MAXIMUM PEAK REVERSE VOLTAGE V	$V_{RSM}$ , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	$I_{RRM}$ AT 150 °C mA
VS-10ETF12THM3	1200	1300	4

### ABSOLUTE MAXIMUM RATINGS

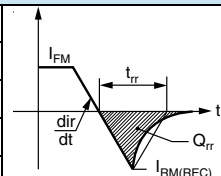
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum average forward current	$I_{F(AV)}$	$T_C = 125$ °C, 180° conduction half sine wave	10	A
Maximum peak one cycle non-repetitive surge current	$I_{FSM}$	10 ms sine pulse, rated $V_{RRM}$ applied	115	
		10 ms sine pulse, no voltage reapplied	140	
Maximum $I^2t$ for fusing	$I^2t$	10 ms sine pulse, rated $V_{RRM}$ applied	66	A <sup>2</sup> s
		10 ms sine pulse, no voltage reapplied	94	
Maximum $I^2\sqrt{t}$ for fusing	$I^2\sqrt{t}$	$t = 0.1$ to 10 ms, no voltage reapplied	940	A <sup>2</sup> √s

**ELECTRICAL SPECIFICATIONS**

PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum forward voltage drop	$V_{FM}$	10 A, $T_J = 25\text{ }^{\circ}\text{C}$		1.33	V
Forward slope resistance	$r_t$	$T_J = 150\text{ }^{\circ}\text{C}$		22.9	$\text{m}\Omega$
Threshold voltage	$V_{F(TO)}$			0.96	V
Maximum reverse leakage current	$I_{RM}$	$T_J = 25\text{ }^{\circ}\text{C}$	$V_R = \text{Rated } V_{RRM}$	0.1	mA
		$T_J = 150\text{ }^{\circ}\text{C}$		4	

**RECOVERY CHARACTERISTICS**

PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Reverse recovery time	$t_{rr}$	$I_F$ at 10 A <sub>pk</sub> 25 A/ $\mu\text{s}$ 25 $^{\circ}\text{C}$	310	ns
Reverse recovery current	$I_{rr}$		4.7	A
Reverse recovery charge	$Q_{rr}$		1.05	$\mu\text{C}$
Typical snap factor	S		0.6	

**THERMAL - MECHANICAL SPECIFICATIONS**

PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		-40 to +150	°C
Maximum thermal resistance junction to case	R <sub>thJC</sub>	DC operation	1.5	°C/W
Maximum thermal resistance junction to ambient	R <sub>thJA</sub>		62	
Typical thermal resistance, case to heatsink	R <sub>thCS</sub>	Mounting surface, smooth and greased	0.5	
Approximate weight			2	g
			0.07	oz.
Mounting torque	minimum		6 (5)	kgf · cm (lbf · in)
	maximum		12 (10)	
Marking device		Case style 2L TO-220AC	10ETF12TH	

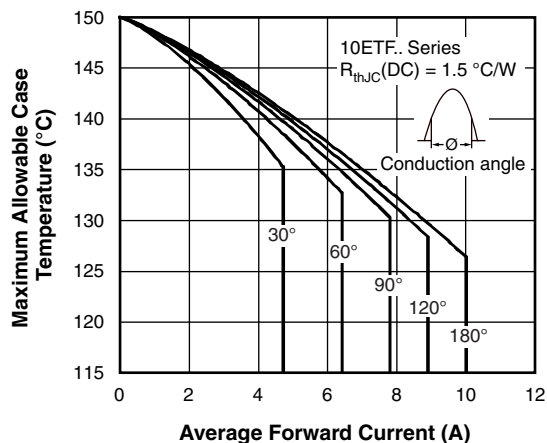


Fig. 1 - Current Rating Characteristics

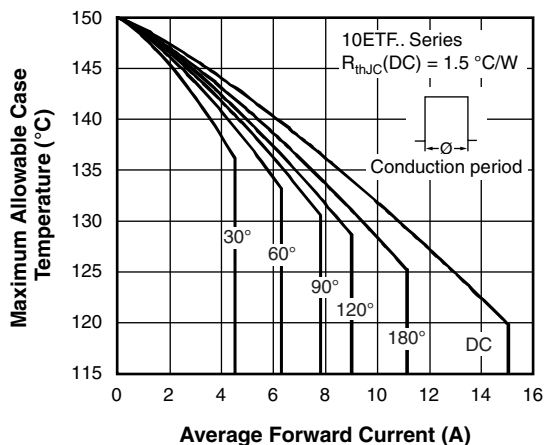


Fig. 2 - Current Rating Characteristics

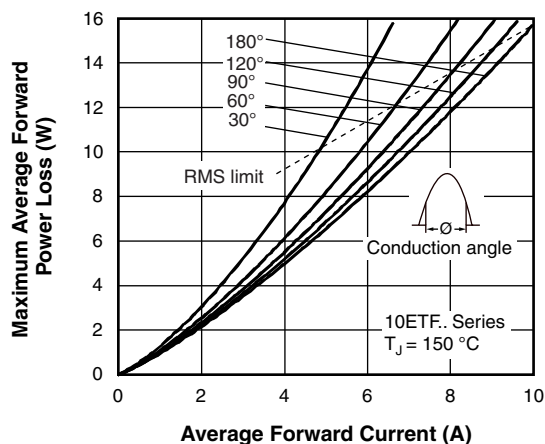


Fig. 3 - Forward Power Loss Characteristics

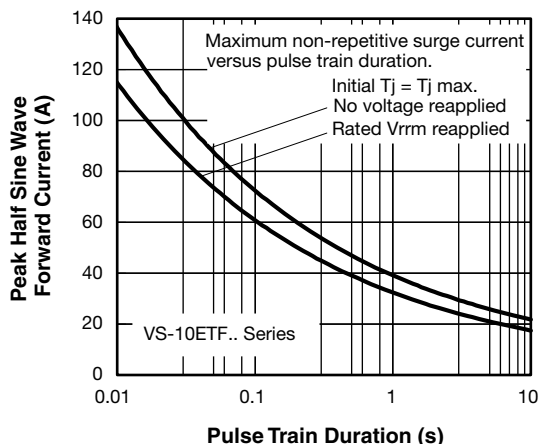


Fig. 6 - Maximum Non-Repetitive Surge Current

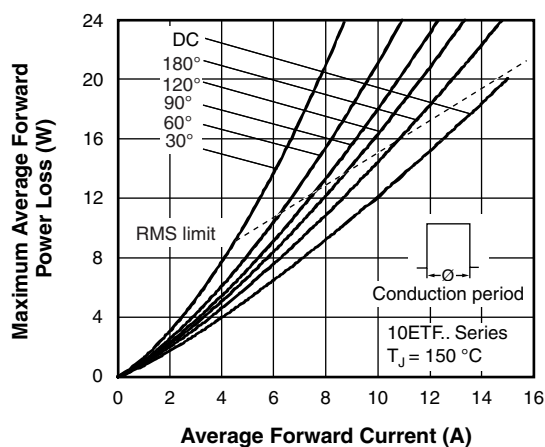


Fig. 4 - Forward Power Loss Characteristics

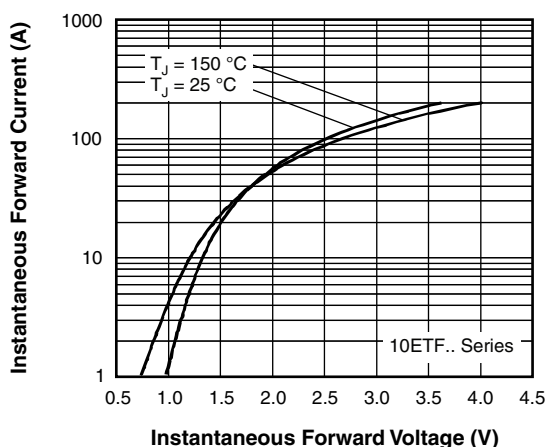


Fig. 7 - Forward Voltage Drop Characteristics

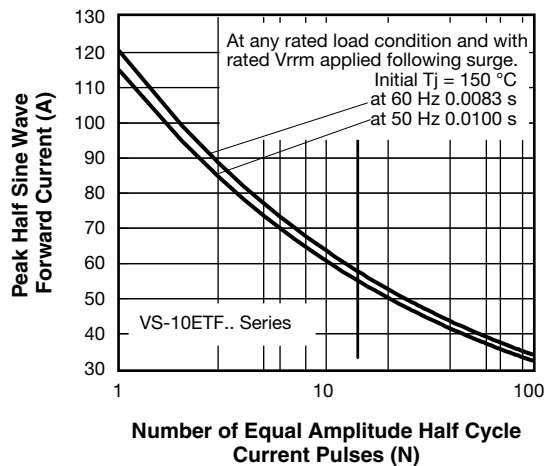
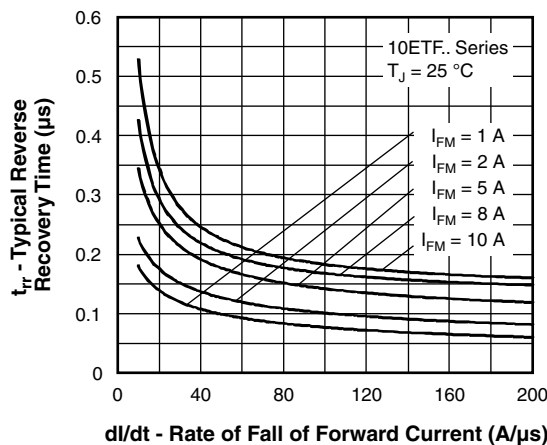
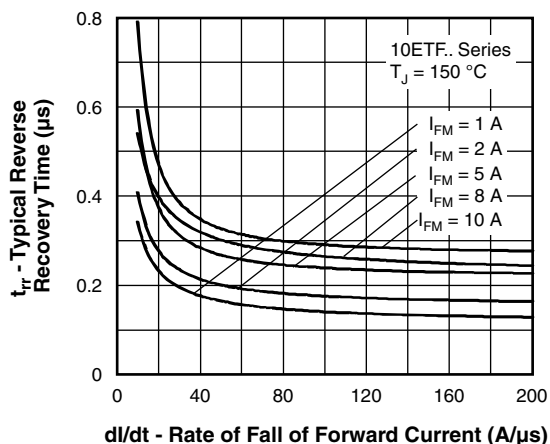
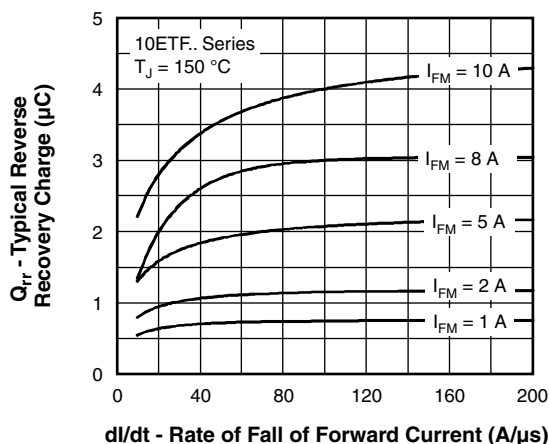
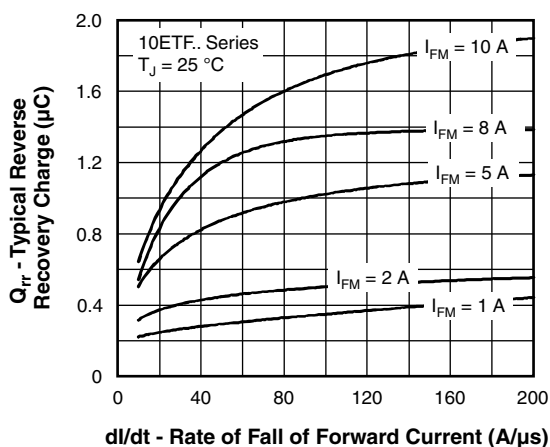
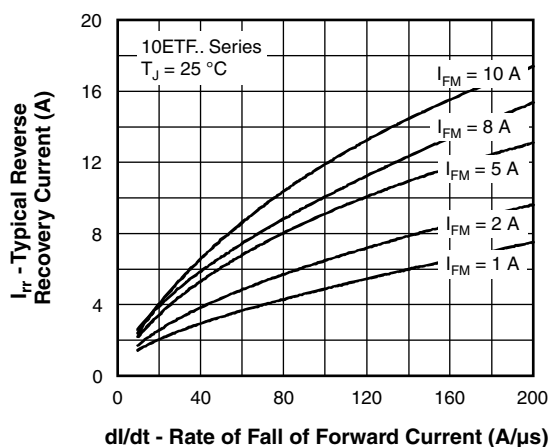
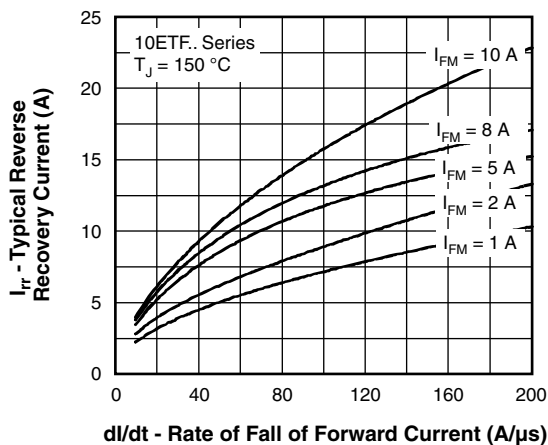
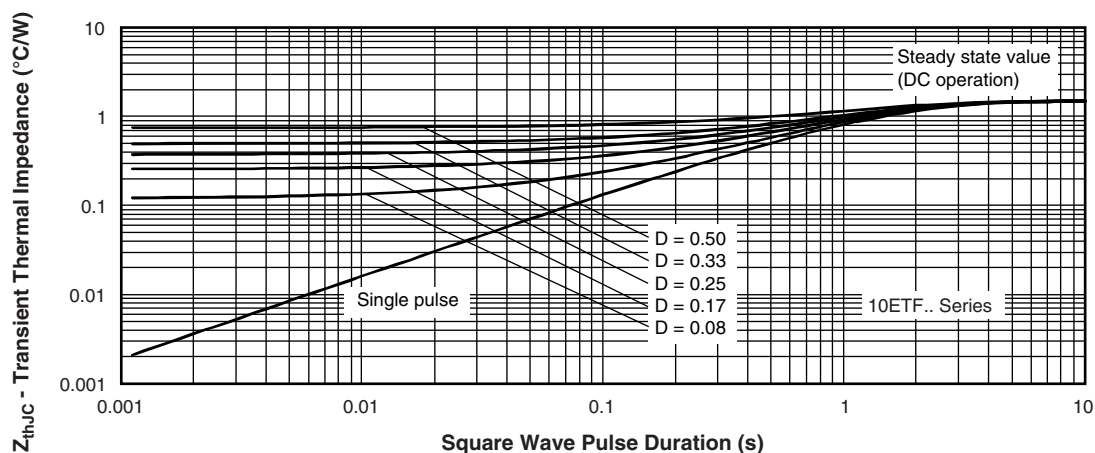


Fig. 5 - Maximum Non-Repetitive Surge Current


Fig. 8 - Recovery Time Characteristics,  $T_j = 25\text{ }^{\circ}\text{C}$


Fig. 9 - Recovery Time Characteristics,  $T_J = 150\text{ }^{\circ}\text{C}$ 

Fig. 11 - Recovery Charge Characteristics,  $T_J = 150\text{ }^{\circ}\text{C}$ 

Fig. 10 - Recovery Charge Characteristics,  $T_J = 25\text{ }^{\circ}\text{C}$ 

Fig. 12 - Recovery Current Characteristics,  $T_J = 25\text{ }^{\circ}\text{C}$ 

Fig. 13 - Recovery Current Characteristics,  $T_J = 150\text{ }^{\circ}\text{C}$


Fig. 14 - Thermal Impedance  $Z_{thJC}$  Characteristics

### ORDERING INFORMATION TABLE

Device code	<b>VS-</b>	<b>10</b>	<b>E</b>	<b>T</b>	<b>F</b>	<b>12</b>	<b>T</b>	<b>H</b>	<b>M3</b>
	①	②	③	④	⑤	⑥	⑦	⑧	⑨

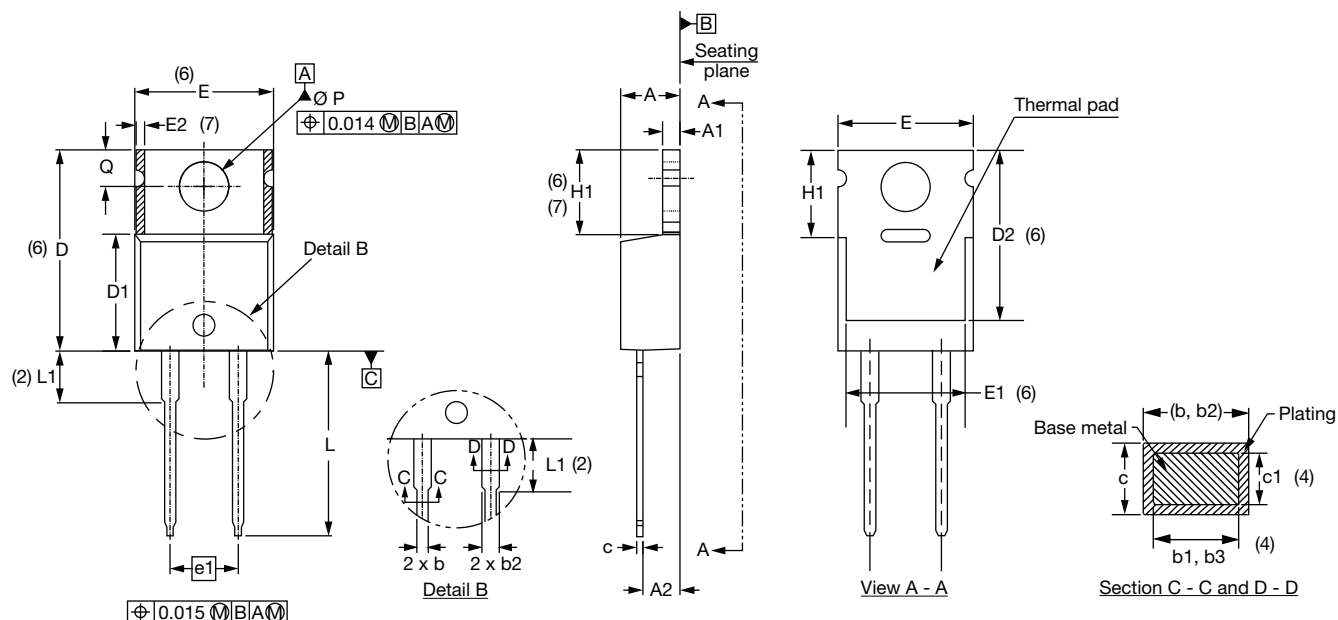
- 1** - Vishay Semiconductors product
- 2** - Current rating (10 = 10 A)
- 3** - Circuit configuration:  
E = 2L TO-220AC
- 4** - Package:  
T = TO-220
- 5** - Type of silicon:  
F = fast soft recovery rectifier
- 6** - Voltage code x 100 =  $V_{RRM}$  ——— **12 = 1200 V**
- 7** -
  - None = TO-220AB
  - T = true pin TO-220
- 8** - H = AEC-Q101 qualified
- 9** - Environmental digit:  
M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

ORDERING INFORMATION (Example)			
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION
VS-10ETF12THM3	50	1000	Antistatic plastic tube

LINKS TO RELATED DOCUMENTS	
Dimensions	<a href="http://www.vishay.com/doc?96069">www.vishay.com/doc?96069</a>
Part marking information	<a href="http://www.vishay.com/doc?95391">www.vishay.com/doc?95391</a>

# TO-220AC 2L

**DIMENSIONS** in millimeters and inches



SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	
A	4.25	4.65	0.167	0.183	
A1	1.14	1.40	0.045	0.055	
A2	2.56	2.92	0.101	0.115	
b	0.69	1.01	0.027	0.040	
b1	0.38	0.97	0.015	0.038	4
b2	1.20	1.73	0.047	0.068	
b3	1.14	1.73	0.045	0.068	4
c	0.36	0.61	0.014	0.024	
c1	0.36	0.56	0.014	0.022	4
D	14.85	15.25	0.585	0.600	3
D1	8.38	9.02	0.330	0.355	
D2	11.68	12.88	0.460	0.507	6
E	10.11	10.51	0.398	0.414	3, 6

## Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension and finish uncontrolled in L1
- (3) Dimension D, D1 and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Dimension b1, b3 and c1 apply to base metal only
- (5) Controlling dimension: inches
- (6) Thermal pad contour optional within dimensions E, H1, D2 and E1
- (7) Dimension E2 x H1 define a zone where stamping and singulation irregularities are allowed
- (8) Outline conforms to JEDEC® TO-220, except D2, where JEDEC® minimum is 0.480"



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